#### **FEE TRANSMITTAL**

## Electronic Version v08

# Stylesheet Version v08.0

Title of Invention

[FLIP CHIP PACKAGE AND MANUFACTURING METHOD THEREOF]

Application Number:

Date:

First Named Applicant: Mr. Yu-Wen Chen
Attorney Docket Number: 10790-US-PA

# **TOTAL FEE AUTHORIZED \$828**

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

# **BASIC FILING FEE**

Fee Description	Fee Code	Amount \$	Fee Paid \$
Utility Filing Fee	1001	770	770
		Subtotal Fo	r Basic Filing Fees: \$ 770

# **EXTRA CLAIM FEES**

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 21	1	1202	18	18
Independent Claims : 2	0	1201	86	0
			Subtotal For Extra	Claims Fees: \$ 18

## **ASSIGNMENT FEES**

Fee Description	Property Number	Quantity	Fee Code	Amount \$	Fee Paid \$	
Recording Each Patent	00000000	1	8021	40	40	
Assignment Per Property Fee						
Subtotal For Additional Fees: \$40						

## **AUTHORIZED BILLING INFORMATION**

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Credit account number: 1000

Expiration Date (YYYYMMDD): 2006-10-31

Authorized name: LEE, HUAI-LU

Billing address: 99999